

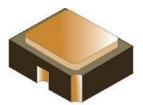


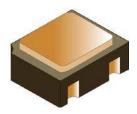
# NPN Silicon Switching Transistor Qualified per MIL-PRF-19500/399

Qualified Levels: JAN, JANTX, AND JANTXV

#### **DESCRIPTION**

This 2N3960UB epitaxial planar transistor is military qualified up to the JANTXV level for high-reliability applications. It features a low profile ceramic UB package. This device is also available in a thru-hole TO-18 package.





**UB Package** 

Also available in:

TO-18 package (leaded) 2N3960

 $\label{lem:lemportant:mportant:form} \textbf{Important:} \ \ \textbf{For the latest information, visit our website } \underline{\ \ \underline{\ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ \ } \underline{\ \ \ \ } \underline$ 

#### **FEATURES**

- Surface mount equivalent of JEDEC registered 2N3960 number
- JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/366.
   (See <u>part nomenclature</u> for all available options.)
- · RoHS compliant

#### **APPLICATIONS / BENEFITS**

- General purpose transistors for medium power applications requiring high frequency switching
- Low profile ceramic package
- Lightweight
- Military and other high-reliability applications

# **MAXIMUM RATINGS** @ $T_C = +25$ ${}^{\circ}C$ unless otherwise noted

Parameters / Test Conditions	Symbol	Value	Unit	
Junction & Storage Temperature Range	$T_J, T_{stg}$	-65 to +200	°C	
Collector-Emitter Voltage		V <sub>CEO</sub>	12	V
Collector-Base Voltage		V <sub>CBO</sub>	20	V
Emitter-Base Voltage		V <sub>EBO</sub>	4.5	V
Total Power Dissipation	@ $T_A = +25  ^{\circ}C^{(1)}$	P <sub>T</sub>	400	mW

Notes: 1. Derate linearly 2.3 mW/°C above T<sub>A</sub> = +25 °C

#### MSC - Lawrence

6 Lake Street, Lawrence, MA 01841 Tel: 1-800-446-1158 or (978) 620-2600 Fax: (978) 689-0803

#### MSC - Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

Website:

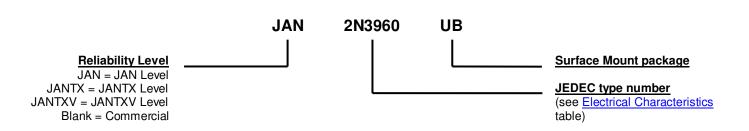
www.microsemi.com



## **MECHANICAL and PACKAGING**

- · CASE: Ceramic with kovar lid
- TERMINALS: Gold plating over nickel under plate.
- MARKING: Part number, date code, manufacturer's ID
- TAPE & REEL option: Standard per EIA-418D. Consult factory for quantities.
- WEIGHT: Less than 0.04 grams
- See Package Dimensions on last page.

# PART NOMENCLATURE



SYMBOLS & DEFINITIONS						
Symbol	Definition					
I <sub>B</sub>	Base current: The value of the dc current into the base terminal.					
I <sub>C</sub>	Collector current: The value of the dc current into the collector terminal.					
V <sub>CB</sub>	Collector-base voltage: The dc voltage between the collector and the base.					
V <sub>CBO</sub>	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.					
$V_{CE}$	Collector-emitter voltage: The dc voltage between the collector and the emitter.					
V <sub>CEO</sub>	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.					
V <sub>CC</sub>	Collector-supply voltage: The supply voltage applied to a circuit connected to the collector.					
V <sub>EB</sub>	Emitter-base voltage: The dc voltage between the emitter and the base					
V <sub>EBO</sub>	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.					



# **ELECTRICAL CHARACTERISTICS** @ T<sub>A</sub> = +25 °C, unless otherwise noted

Parameters / Test Conditions	Symbol	Min.	Max.	Unit					
OFF CHARACTERISTICS									
Collector-Emitter Breakdown Voltage									
$I_C = 10 \mu A$ , pulsed	$V_{(BR)CEO}$	12		V					
Collector-Base Cutoff Current $V_{CB} = 20 \text{ V}$	I <sub>CBO</sub>		10	μΑ					
Emitter-Base Cutoff Current V <sub>EB</sub> = 4.5 V	I <sub>EBO</sub>		10	μА					
Collector-Emitter Cutoff Current $V_{CE} = 10 \text{ V}, V_{EB} = 0.4 \text{ V}$ $V_{CE} = 10 \text{ V}, V_{EB} = 2.0 \text{ V}$	I <sub>CEX1</sub>		1 5	μA nA					

# ON CHARACTERISTICS (1)

Forward-Current Transfer Ratio $I_C = 1.0 \text{ mA}, V_{CE} = 1 \text{ V}$ $I_C = 10 \text{ mA}, V_{CE} = 1 \text{ V}$ $I_C = 30 \text{ mA}, V_{CE} = 1 \text{ V}$	h <sub>FE</sub>	40 60 30	300	
Collector-Emitter Saturation Voltage $I_C = 1.0$ mA, $I_B = 0.1$ mA $I_C = 30$ mA, $I_B = 3.0$ mA	V <sub>CE(sat)</sub>		0.2 0.3	V
Base-Emitter Saturation Voltage $I_C = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$ $I_C = 30 \text{ mA}, V_{CE} = 1.0 \text{ V}$	V <sub>BE</sub>		0.8 1.0	V

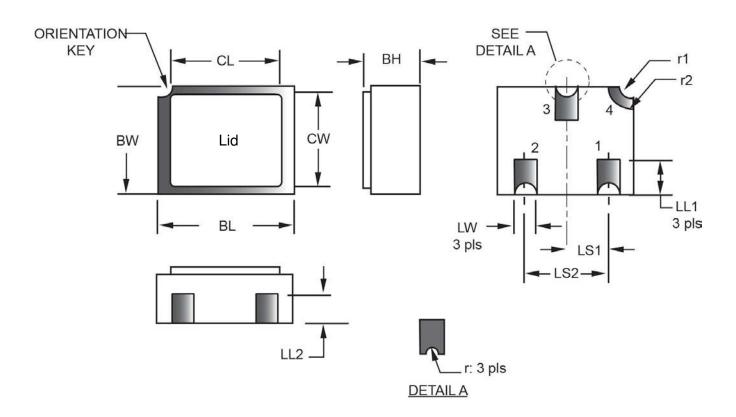
# **DYNAMIC CHARACTERISTICS**

Forward Current Transfer Ratio, Magnitude $I_C = 5.0$ mA, $V_{CE} = 4$ V, $f = 100$ MHz $I_C = 10$ mA, $V_{CE} = 4$ V, $f = 100$ MHz $I_C = 30$ mA, $V_{CE} = 4$ V, $f = 100$ MHz	h <sub>fe</sub>	13 14 12		
Output Capacitance $V_{CB} = 4 \text{ V}, I_E = 0, 100 \text{ kHz} \leq f \leq 1 \text{ MHz}$	$C_obo$		2.5	pF
Input Capacitance $V_{EB}=0.5~V,~I_{C}=0,~100~kHz \leq f \leq 1.0~MHz$	C <sub>ibo</sub>		2.5	pF

<sup>(1)</sup> Pulse Test: pulse width = 300  $\mu$ s, duty cycle  $\leq$  2.0%



# **PACKAGE DIMENSIONS**



		Dimer	sions			Dimensions					
Symbol	Inch		Millimeters		Note	Symbol	Symbol Inch		Millimeters		Note
	Min	Max	Min	Max			Min	Max	Min	Max	
BH	0.046	0.056	1.17	1.42		LS₁	0.035	0.040	0.89	1.02	
BL	0.115	0.128	2.92	3.25		LS <sub>2</sub>	0.071	0.079	1.80	2.01	
BW	0.085	0.108	2.16	2.74		LW	0.016	0.024	0.41	0.61	
CL	-	0.128		3.25		r	-	0.008	-	0.203	
CW	-	0.108		2.74		r <sub>1</sub>	-	0.012	-	0.305	
LL <sub>1</sub>	0.022	0.038	0.56	0.97		r <sub>2</sub>	-	0.022	-	0.559	
LL <sub>2</sub>	0.017	0.035	0.43	0.89							

### **NOTES:**

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Hatched areas on package denote metallized areas.
- 4. Lid material: Kovar
- 5. Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- 6. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi x$  symbology.